

High Voltage NPN Silicon Power Transistors

... designed for high voltage inverters, switching regulators and line-operated amplifier applications. Especially well suited for switching power supply applications.

- High Collector–Emitter Sustaining Voltage –
 $V_{CEO(sus)} = 250 \text{ Vdc (Min)}$
- Excellent DC Current Gain
 $h_{FE} = 10\text{--}75 @ I_C = 2.5 \text{ Adc}$
- Low Collector–Emitter Saturation Voltage @ $I_C = 2.5 \text{ Adc}$ –
 $V_{CE(sat)} = 1.0 \text{ Vdc (Max)}$

MAXIMUM RATINGS (1)

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	250	Vdc
Collector–Base Voltage	V_{CB}	350	Vdc
Emitter–Base Voltage	V_{EB}	6.0	Vdc
Collector Current – Continuous – Peak	I_C	5.0 10	A dc
Base Current	I_B	2.0	A dc
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	80 0.64	Watts W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	–65 to +150	$^\circ\text{C}$

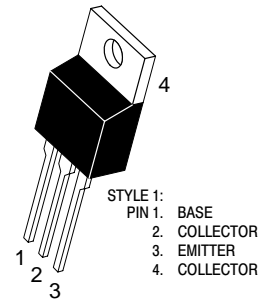
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.56	$^\circ\text{C/W}$

(1) Indicates JEDEC Registered Data.

2N6497

**5 AMPERE
POWER TRANSISTORS
NPN SILICON
250 VOLT
80 WATTS**



**CASE 221A-09
TO-220AB**

2N6497

*ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (1) ($I_C = 25\text{ mAdc}$, $I_B = 0$)	$V_{CEO(sus)}$	250	–	–	Vdc
Collector Cutoff Current ($V_{CE} = 350\text{ Vdc}$, $V_{BE(off)} = 1.5\text{ Vdc}$) ($V_{CE} = 175\text{ Vdc}$, $V_{BE(off)} = 1.5\text{ Vdc}$, $T_C = 100^\circ\text{C}$)	I_{CEX}	–	–	1.0 10	mAdc
Emitter Cutoff Current ($V_{BE} = 6.0\text{ Vdc}$, $I_C = 0$)	I_{EBO}	–	–	1.0	mAdc

ON CHARACTERISTICS (1)

DC Current Gain ($I_C = 2.5\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$) ($I_C = 5.0\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$)	h_{FE}	10 3.0	– –	75 –	–
Collector–Emitter Saturation Voltage ($I_C = 2.5\text{ Adc}$, $I_B = 500\text{ mAdc}$) ($I_C = 5.0\text{ Adc}$, $I_B = 2.0\text{ Adc}$)	$V_{CE(sat)}$	– –	– –	1.0 5.0	Vdc
Base–Emitter Saturation Voltage ($I_C = 2.5\text{ Adc}$, $I_B = 500\text{ mAdc}$) ($I_C = 5.0\text{ Adc}$, $I_B = 2.0\text{ Adc}$)	$V_{BE(sat)}$	– –	– –	1.5 2.5	Vdc

DYNAMIC CHARACTERISTICS

Current–Gain – Bandwidth Product ($I_C = 250\text{ mAdc}$, $V_{CE} = 10\text{ Vdc}$, $f = 1.0\text{ MHz}$)	f_T	5.0	–	–	MHz
Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $f = 100\text{ kHz}$)	C_{ob}	–	–	150	pF

SWITCHING CHARACTERISTICS

Rise Time ($V_{CC} = 125\text{ Vdc}$, $I_C = 2.5\text{ Adc}$, $I_{B1} = 0.5\text{ Adc}$)	t_r	–	0.4	1.0	μs
Storage Time ($V_{CC} = 125\text{ Vdc}$, $I_C = 2.5\text{ Adc}$, $V_{BE} = 5.0\text{ Vdc}$, $I_{B1} = I_{B2} = 0.5\text{ Adc}$)	t_s	–	1.4	2.5	μs
Fall Time ($V_{CC} = 125\text{ Vdc}$, $I_C = 2.5\text{ Adc}$, $I_{B1} = I_{B2} = 0.5\text{ Adc}$)	t_f	–	0.45	1.0	μs

*Indicates JEDEC Registered Data.

(1) Pulse Test: Pulse Width $\leq 300\ \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

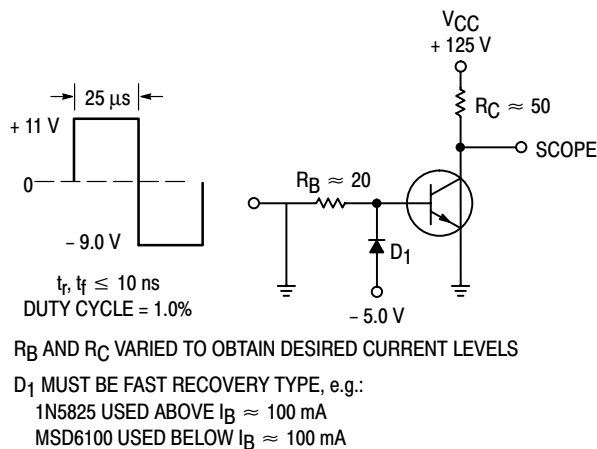


Figure 1. Switching Time Test Circuit

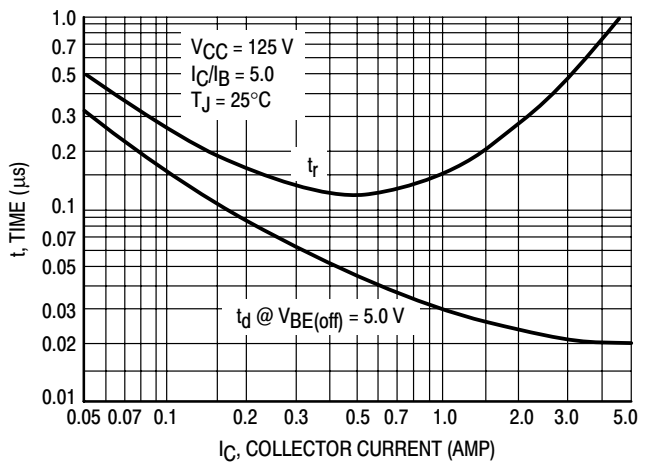


Figure 2. Turn–On Time

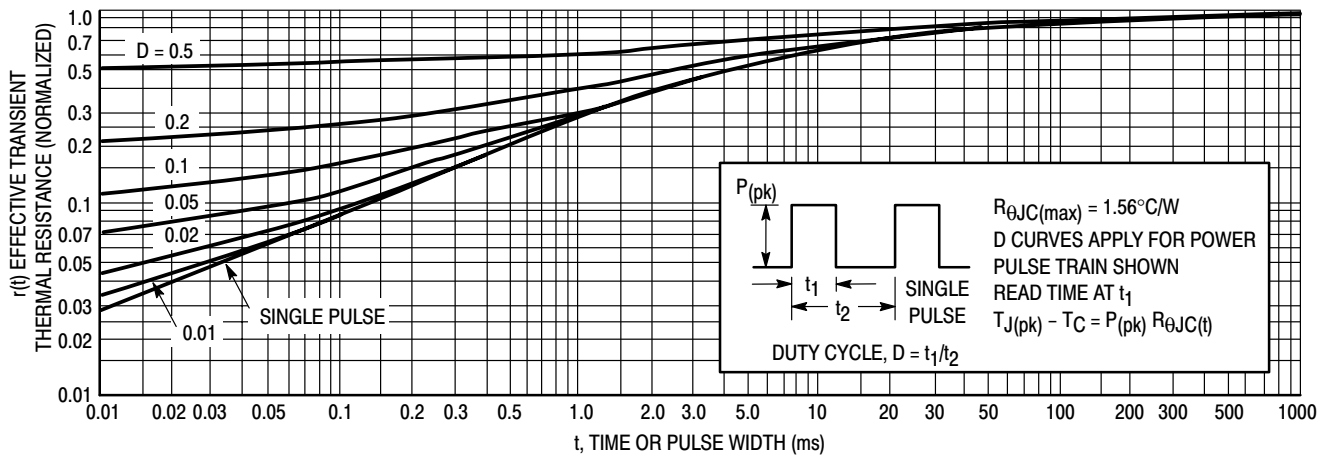


Figure 3. Thermal Response

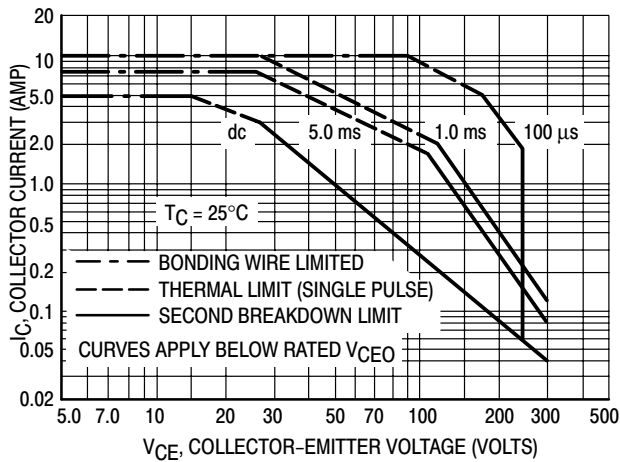


Figure 4. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 4 is based on $T_C = 25^\circ C$; $T_J(pk)$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_J(pk) \leq 150^\circ C$. $T_J(pk)$ may be calculated from the data in Figure 3. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltage shown on Figure 4 may be found at any case temperature by using the appropriate curve on Figure 6.

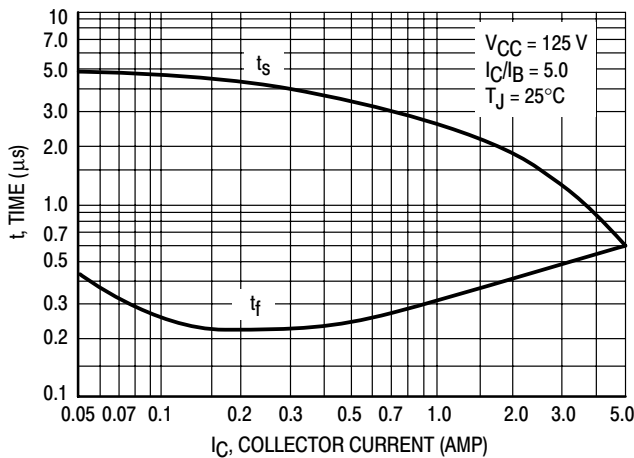


Figure 5. Turn-Off Time

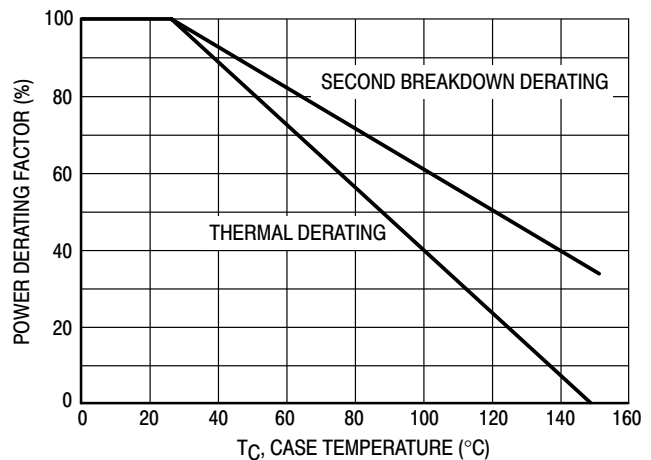


Figure 6. Power Derating

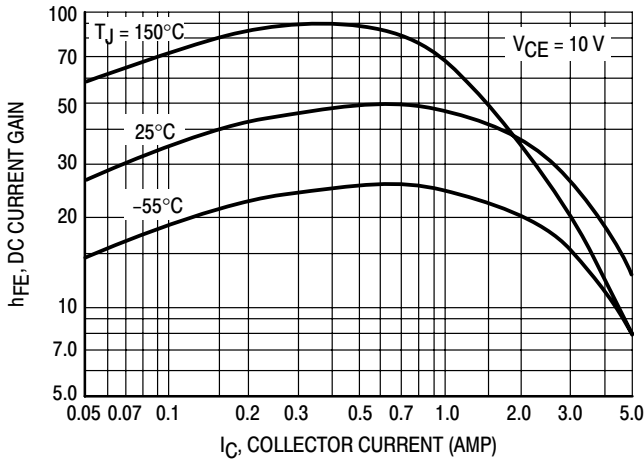


Figure 7. DC Current Gain

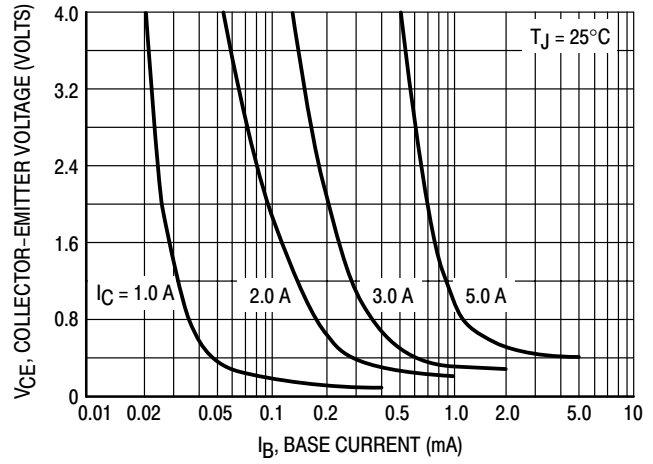


Figure 8. Collector Saturation Region

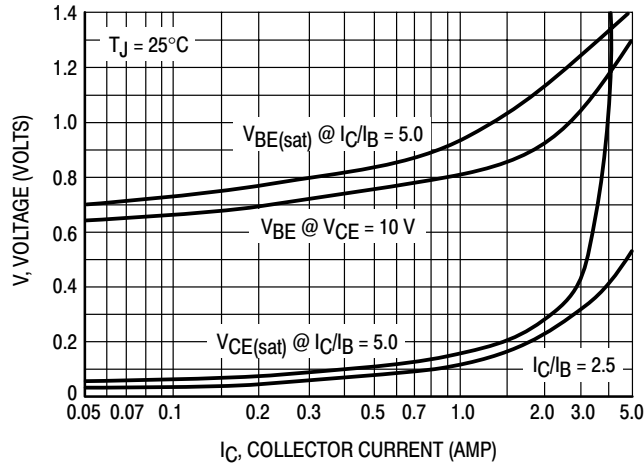


Figure 9. "On" Voltages

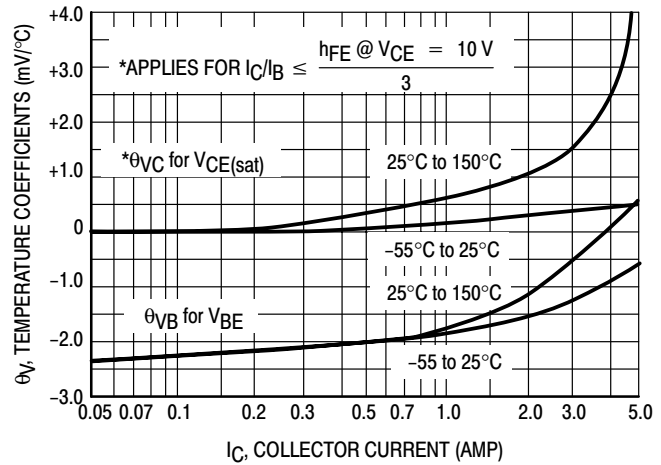


Figure 10. Temperature Coefficients

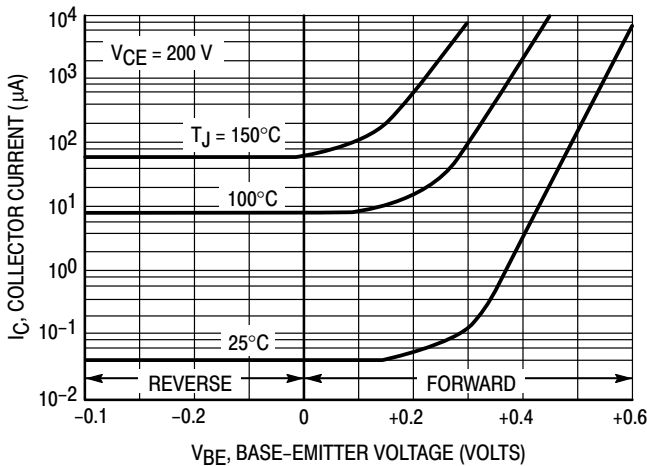


Figure 11. Collector Cutoff Region

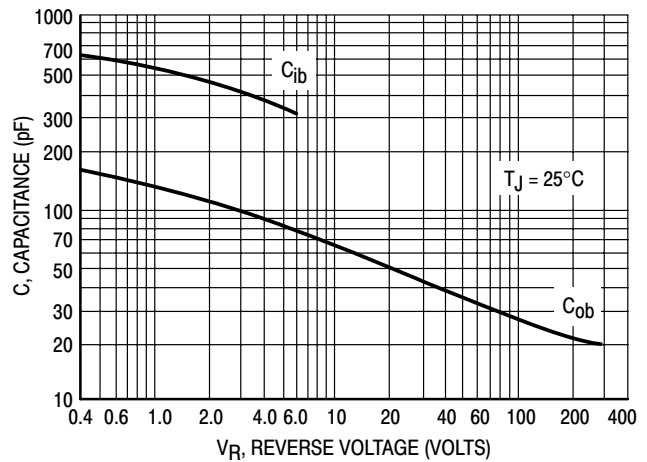
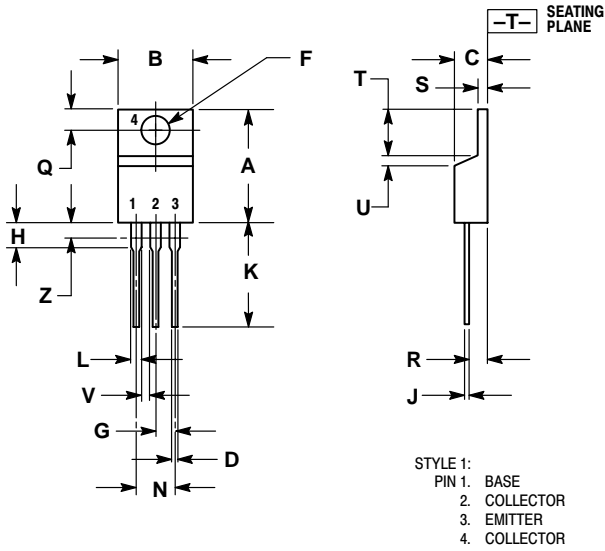


Figure 12. Capacitance

2N6497

PACKAGE DIMENSIONS

TO-220AB CASE 221A-09 ISSUE AA




NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

Notes

Notes

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